

Product Change Notice / Termination Notification

PCN-No.: 20250822-V1.0

Date: 22nd Aug 2025

Type of Change	☐ PCN ☒ PTN		
Change Title	EOL: IM DDR4 4Gb (A-die) and DDR4 4Gb (B-die)		
Change Classification	☒ Major ☐ Minor		
Change Item	☐ Design ☐ Raw Material ☐ Wafer FAB ☐ Package Assembly ☐ Testing ☒ Others: Products EOL		
Affected Product(s)	<u>IM DDR4 4Gb x8 (A-Die)</u> a/ Component: IM4G08D4GABG b/ Module: ⇒ IMM512M(64/72)D4(DU/SO)S8xx-Axxx(I) <u>IM DDR4 4Gb x8 and x16 (B-die)</u> a/ Component: IM4G(08/16)D4GBBG b/ Modules: ⇒ IMM512M(64/72)D4(DU/SO)S8xx-Bxxx(I) ⇒ IMM256M64D4(DU/SO)S16xx-Bxxx(I)		
Description	This notification is to inform you that IM is going to execute an End Of Life (EOL) process for DDR4 4Gb A-die and B-die products (see below for specific part numbers). After a thorough review of our existing product offering, we have made the determination to discontinue these products in order to provide you with more advanced products while more efficiently managing our product portfolio. <u>Please place your orders in a timely manner prior to the Last Time Buy(LTB) date listed on this notification to avoid product availability issues. Please note that all placed orders and planned shipments between the LTB and LTS dates are Non-Cancelable and Non-Returnable (NCNR).</u> Please contact your local IM Sales Representative if you have any questions regarding this notification.		
Reason for Change(s)	Strategy change in DRAM market development		
Impact of Change(s)	Replacement parts are available and suggested as below:		
Part Numbers	Last Time Buy	Last Time Ship	Suggested Replacement
IM4G08D4GABG-xxx(I)	15 th -Dec-2025	16 th -Mar-2026	IM4G08D4GCBG-062(I)**
IM4G08D4GBBG-xxx(I)			
IM4G16D4GBBG-xxx(I)			IM4G16D4GCBG-062(I)**
IMM512M(64/72)D4(DU/SO)S8xx-(A/B)xxx(I)			IMM512M(64/72)D4(DU/SO)S8xx-Cxxx(I)
IMM256M64D4(DU/SO)S16xx-Bxxx(I)			IMM256M64(DU/SO)S16xx-Cxxx(I)

** IM DDR4 4Gb C-die products are now under development and samples ready in Q4 2025.